

SSC8135GSB

P-Channel Enhanced MOSFET

VDS	VGS	RDSON Typ.	ID
201/	.101/	27mΩ@-4V5	64
-300	±ΙΖν	35mΩ@-2V5	-0A

> Description

The SSC8035GSB is P-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC-DC conversion and power switch applications.

- ➤ Applications
- Load Switch
- Portable Switch
- DCDC conversion
- Charging
- Driver for Relay, Motor, Solenoid, LED etc.

Pin configuration





SOT-23-6L



Marking

> Ordering Information

Device	Package	Shipping
SSC8135GSB	SOT-23-6L	3000/Reel



> Absolute Maximum Ratings (T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
Vdss	Drain-to-Source Voltage	-30	V
V _{GSS}	Gate-to-Source Voltage	±12	V
lo	Continuous Drain Current ^a	-6	А
I _{DM}	Pulsed Drain Current ^b	-24	А
PD	Power Dissipation ^a	1.6	W
TJ	Operation junction temperature	-55 to 150	°C
Т _{stg}	Storage temperature range	-55 to 150	°C

➤ Thermal Resistance Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Typical	Maximum	Unit
Reja	Junction-to-Ambient Thermal Resistance ^a		80	°C/W

Note:

- a. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with T_A=25°C. The value in any given application depends on the user is specific board design. The current rating is based on the t≤ 10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.



➤ Electronics Characteristics (T_A=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	VGS=0V, ID=-250uA	-30			V
$V_{GS \ (th)}$	Gate Threshold Voltage	VDS=VGS, ID=-250uA	-0.7	-1.0	- 1.3	V
	Drain-Source On-	VGS=-4.5V, ID=-1A		27	36	
RDS (on)	Resistance	VGS=-2.5V, ID=- 1A		35	46	mΩ
Idss	Zero Gate Voltage Drain Current	VDS=-30V, VGS=0V			- 1	μA
I _{GSS}	Gate-Source leak current	VGS=±12V, VDS=0V			±100	nA
G _{FS}	Transconductance	VDS=- 10V, ID=-2A		9		S
V _{SD}	Forward Voltage	VGS=0V, IS=-1A		0.8	1.3	V
Ciss	Input Capacitance			1520		
Coss	Output Capacitance	VDS= -15V, VGS=0V, f=1MHz		170		pF
Crss	Reverse Transfer Capacitance			155		
TD(ON)	Turn-on delay time			21		
Tr	Rise time	VGS= -4.5V, RL=15R		10		
TD(OFF)	Turn-off delay time	VDS= -15V, RG=6R, ID=-1A		62		ns
Tf	Fall time			23		
QG	Total Gate Charge			21		
QGS	Gate to Source Charge	VGS=- 4.5V, VDS=-15V ID=-1A		3.7		nC
Qgd	Gate to Drain Charge			5.3		



➤ Typical Characteristics (TA=25°C unless otherwise noted)





SSC8135GSB

> Package Information



	N	ILLIMETE	R
SYMBOL	MIN	NOM	MAX
Α	1.06	1.15	1.24
* A1	0.01	0.05	0.09
* A2	1.05	1.10	1.15
A3	0.65	0.70	0.75
* b	0.30	0.35	0.45
* с	0.117	0.127	0.157
* D	2.87	2.92	2.97
* E	2.72	2.80	2.88
* E1	1.55	1.60	1.65
* e	0.90	0.95	1.00
* L	0.32	0.40	0.48
* L1	0.55	0.60	0.65
R	C	.10 REF	
R1	0	.12 REF	-
* 0	0		8°
0 1	8°	10°	12°
02	10°	12°	14°

➢ History Version

V1.0 Product datasheet 2023-02-14

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